

◆ Features:

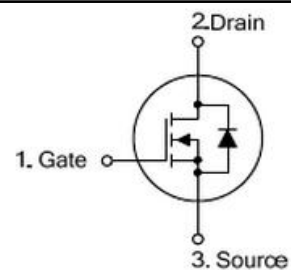
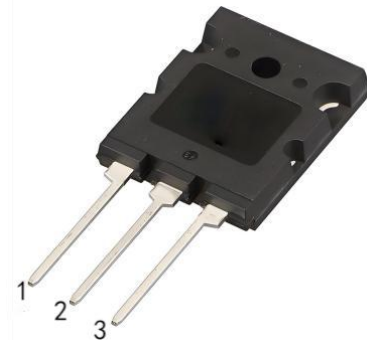
- ✧ Fast switching speed
开关速度快
- ✧ High input impedance and low level drive
高输入阻抗和低电平驱动
- ✧ Avalanche energy tested
雪崩能量测试
- ✧ Improved dv/dt capability, high ruggedness
提高 dv/dt 能力, 高耐用性

◆ Applications

- ✧ High efficiency switch mode power supplies
高效率开关电源
- ✧ Power factor correction
功率因数校正
- ✧ Electronic lamp ballast
电子整流器

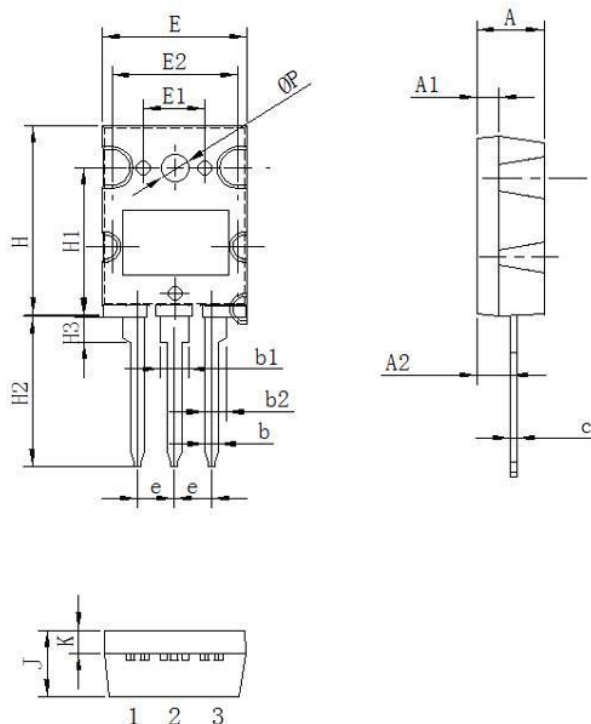


TO-264



外形名称: TO-264

基本尺寸



Symbol	单位 mm		
	Min	Nom	Max
A	4.80	5.00	5.20
A1	1.80	2.00	2.20
A2	3.20	3.40	3.60
b	0.80	1.00	1.20
b1	2.90	3.10	3.30
b2	2.40	2.60	2.80
c	0.50	0.60	0.70
e	5.25	5.45	5.65
E	19.8	20.0	20.2
E1	17.6	17.8	18.0
E2	8.60	8.80	9.00
H	25.8	26.0	26.2
H1	19.8	20.0	20.2
H2	19.8	20.3	20.8
H3	2.00	2.50	3.00
G	6.00	6.20	6.40
ΦP	3.00	3.20	3.40
J	4.80	5.00	5.20
K	1.30	1.50	1.70

**IXFK44N50P-OSEN****500V N-CHANNEL MOSFET**

◆ **Absolute Maximum Ratings** (Tc=25°C)

Symbol	Parameters	Ratings	Unit
V _{DSS}	Drain-Source Voltage 漏源电压	500	V
V _{GS}	Gate-Source Voltage-Continuous 栅源电压	±30	V
I _D	Drain Current-Continuous (Note 2) 漏极持续电流	44	A
I _{DM}	Drain Current-Single Plused (Note 1) 漏极单次脉冲电流	110	A
P _D	Power Dissipation (Note 2) 功率损耗	658	W
T _j	Max.Operating junction temperature 最大结温	150	°C

◆ **Electrical characteristics** (Tc=25°C unless otherwise noted)

Symbol	Parameters	Min	Typ	Max	Units	Conditions
Static Characteristics						
B _{VDSS}	Drain-Source Breakdown Voltage Current (Note 1) 漏极击穿电压	500	--	--	V	I _D =250μA, V _{GS} =0V, T _J =25°C
V _{GS(th)}	Gate Threshold Voltage 栅极开启电压	2.0	--	4.0	V	V _{DS} =V _{GS} , I _D =250μA
R _{DS(on)}	Drain-Source On-Resistance 漏源导通电阻	--	--	140	mΩ	V _{GS} =10V, I _D =20A
I _{GSS}	Gate-Body Leakage Current 栅极漏电流	--	--	±100	nA	V _{GS} =±30V, V _{DS} =0
I _{DSS}	Zero Gate Voltage Drain Current 零栅极电压漏极电流	--	--	1	μA	V _{DS} =500V, V _{GS} =0
g _{fs}	Forward Trans conductance 正向跨导	--	35	--	S	V _{DS} =20V, I _D =25A

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Switching Characteristics						
T _{d (on)}	Turn-On Delay Time 开启延迟时间	--	30	--	ns	V _{DS} =250V, I _D =22A, R _G =3Ω (Note 2)
T _r	Rise Time 上升时间	--	32	--	ns	
T _{d (off)}	Turn-Off Delay Time 关闭延迟时间	--	89	--	ns	
T _f	Fall Time 下降时间	--	30	--	ns	
Q _g	Total Gate Charge 栅极总电荷	--	103	--	nC	V _{DS} =250V, V _{GS} =10V, I _D =22A (Note 2)
Q _{gs}	Gate-Source Charge 栅源极电荷	--	38	--	nC	
Q _{gd}	Gate-Drain Charge 栅漏极电荷	--	35	--	nC	
Dynamic Characteristics						
C _{iss}	Input Capacitance 输入电容	--	8100	--	pF	V _{DS} =25V, V _{GS} =0, f=1MHz
C _{oss}	Output Capacitance 输出电容	--	770	--	pF	
C _{rss}	Reverse Transfer Capacitance 反向传输电容	--	65	--	pF	
I _S	Continuous Drain-Source Diode Forward Current (Note 2) 二极管导通正向持续电流	--	--	44	A	
V _{SD}	Diode Forward On-Voltage 二极管正向导通电压	--	--	1.2	V	I _S =30A, V _{GS} =0
R _{th(j-c)}	Thermal Resistance, Junction to Case 结到外壳的热阻	--	--	0.19	°C/W	

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: PW ≤ 300us , duty cycle ≤ 2%.